

## (17) UK Patent Application (19) GB (11) 2 116 370 A

(21) Application No 83023/8  
 (22) Date of filing 28 Jan 1983  
 (30) Priority data  
 (31) 57/012289  
 (32) 30 Jan 1982  
 (33) Japan (JP)  
 (43) Application published  
 21 Sep 1983

(51) INT CL<sup>3</sup>  
 H05K 1/02

(52) Domestic classification  
 H1R AS

(56) Documents cited  
 None

(58) Field of search  
 H1R

(71) Applicant  
 Nippon Mektron Ltd.  
 (Japan),  
 Seiwa Building, 12-15  
 Shiba Daimon 1-chome,  
 Minato-ku, Tokyo, Japan

(72) Inventors  
 Katsuyuki Yatabe,  
 Seiji Toke

(74) Agent and/or Address for  
 Service  
 Frank B. Dehn and Co.,  
 Imperial House, 15-19  
 Kingsway, London  
 WC2B 6UZ

## (54) Flexible circuit board

(57) A flexible circuit board comprises  
 a base film 1 with a circuit pattern 2  
 thereon, a cover film 3 over part of the  
 circuit pattern which leaves an

exposed connection portion 2A of the  
 circuit pattern, and stress relief  
 apertures 5, 6 in the cover film and/or  
 the base film adjacent the edge 4 of  
 the cover film to prevent stress  
 concentrations which cause breaking  
 of the circuit pattern.

*Φ mention des  
types de connexions.*

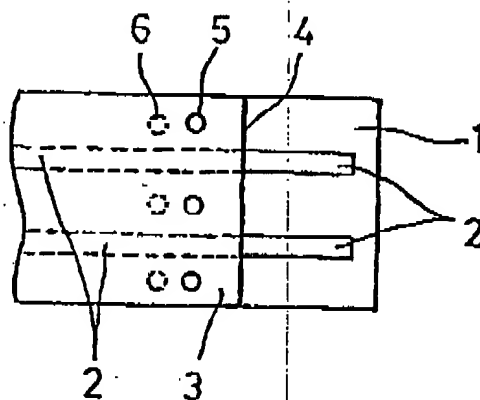


FIG. 3

GB 2 116 370 A

BEST AVAILABLE COPY